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| X FACSIMILE COVER SHEET NEW APPLICATION DECLARATION (# Pages) ASSIGNMENT (# Pages) FORMAL DRAWINGS INFORMAL DRAWINGS CONTINUATION APP'N (# Pages) DIVISIONAL APP'N | | X AMENDMENT (6 Pages) EOT (# Month) NOTICE OF APPEAL APPEAL (# Pages) ISSUE FEE (# Pages) PETITION TO REVIVE | |
| NAME OF INVENTOR(S): Yew | | RECEIPT DATE & SERIAL NO.: | |
| lew | | Serial No.: 10/612,129 | |
| TITLE OF INVENTION: | | Filing Date: 7/2/2003 | 150 |
| DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE | | | |
| TI FILE NO.; | DEPOSIT ACCT. NO.: | | |
| TI-26239.1 | 20-0668 | | ' |
| FAXED: 05/21/2004 DUE: 06/01/2004 | | .1 | |
| ATTY/SEC'Y: WDS/ttc | | | ı |

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Yew

Docket No: TI-26239.1

Serial No:

10/612,129

Examiner:

Cao, Phat X.

Filed:

7/2/2003

Art Unit:

2814

For:

DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC

SUBSTRATE -

AMENDMENT UNDER 37 C.F.R. § 1.115

Assistant Commissioner For Patents Washington, DC 20231

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Tommie Chambers

Office at 703-872-9306 on _

Dear Sir:

Responsive to the Office Action mailed March 1, 2004 in connection with the above identified application, Applicants respectfully submit the following amendments and remarks.